Dual Common Cathode Schottky Barrier Diodes

These Schottky barrier diodes are designed for high speed switching applications, circuit protection, and voltage clamping. Extremely low forward voltage reduces conduction loss. Miniature surface mount package is excellent for hand-held and portable applications where space is limited.

Features

- Extremely Fast Switching Speed
- Low Forward Voltage 0.35 V (Typ) @ $I_F = 10 \text{ mA}$
- This is a Pb–Free Device

MAXIMUM RATINGS (T_J = $125^{\circ}C$ unless otherwise noted)

Rating	Symbol	Value	Unit
Reverse Voltage	V _R	30	Volts
Forward Power Dissipation @ T _A = 25°C Derate above 25°C	P _F	190 1.9	mW mW/°C
Forward Current (DC)	١ _F	200 Max	mA
Junction Temperature	TJ	125 Max	°C
Storage Temperature Range	T _{stg}	-55 to +150	°C
Thermal Resistance Junction-to-Ambient (Note 1)	R_{\thetaJA}	525	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

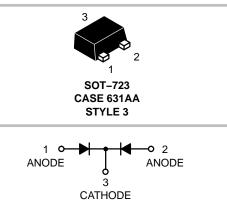
1. FR-4 board with minimum mounting pad.



ON Semiconductor®

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30 VOLTS DUAL COMMON CATHODE SCHOTTKY BARRIER DIODES



MARKING DIAGRAM



5C = Specific Device Code D = Date Code

ORDERING INFORMATION

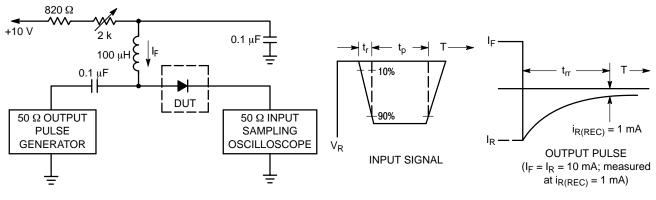
Device	Package	Shipping [†]
NSR30CM3T5G	SOT-723 (Pb-Free)	8000/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

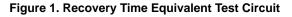
ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted) (EACH DIODE)

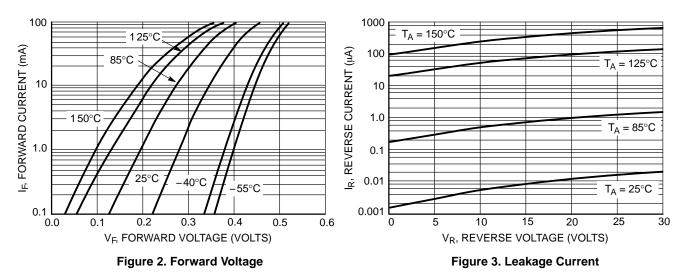
Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Breakdown Voltage $(I_R = 10 \ \mu A)$	V _{(BR)R}	30	-	_	V
Total Capacitance ($V_R = 1.0 V, f = 1.0 MHz$)	CT	_	7.6	10	pF
Reverse Leakage $(V_R = 25 V)$	۱ _R	-	0.5	2.0	μΑ
Forward Voltage $(I_F = 0.1 \text{ mA})$ $(I_F = 1.0 \text{ mA})$ $(I_F = 10 \text{ mA})$ $(I_F = 30 \text{ mA})$ $(I_F = 100 \text{ mA})$	V _F	- - - -	0.22 0.29 0.35 0.41 0.52	0.24 0.32 0.40 0.50 0.80	V
Reverse Recovery Time $(I_F = I_R = 10 \text{ mA}, I_{R(REC)} = 1.0 \text{ mA}, Figure 1)$	t _{rr}	-	-	5.0	ns
Forward Current (DC)	١ _F	-	-	200	mA
Repetitive Peak Forward Current	I _{FRM}	_	-	300	mA
Non-Repetitive Peak Forward Current (t < 1.0 s)	I _{FSM}	-	-	600	mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



Notes: 1. A 2.0 k Ω variable resistor adjusted for a Forward Current (I_F) of 10 mA. 2. Input pulse is adjusted so I_{R(peak)} is equal to 10 mA. 3. t_p » t_{rr}





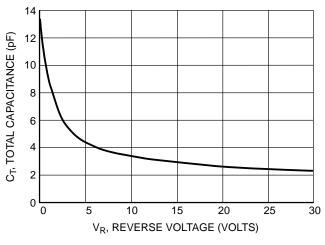
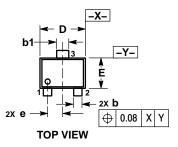
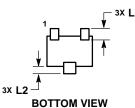


Figure 4. Total Capacitance

PACKAGE DIMENSIONS

SOT-723 CASE 631AA **ISSUE D**





HE - C

SIDE VIEW

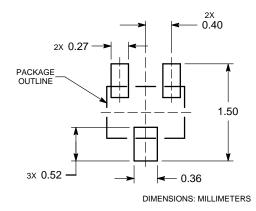
NOTES

- DIMENSIONING AND TOLERANCING PER ASME
- Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL. DIMENSIONS D AND E DO NOT INCLUDE MOLD 3
- FLASH, PROTRUSIONS OR GATE BURRS.

	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	0.45	0.50	0.55	
b	0.15	0.21	0.27	
b1	0.25	0.31	0.37	
С	0.07	0.12	0.17	
D	1.15	1.20	1.25	
Е	0.75	0.80	0.85	
е	0.40 BSC			
ΗE	1.15	1.20	1.25	
L	0.29 REF			
L2	0.15	0.20	0.25	

STYLE 3: PIN 1. ANODE 2. ANODE 3. CATHODE

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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